

	L #	Hits	Search Text	DBs	Errors
1	L1	2768	printed with circuit with board with holder	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
2	L2	72336	rotat\$5 with horizontal with (axis or axes)	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
3	L3	3146	translat\$5 with vertical with (axis or axes)	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
4	L4	0	1 and 2 and 3	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0

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2	L2	72336	rotat\$5 with horizontal with (axis or axes)	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
3	L3	3146	translat\$5 with vertical with (axis or axes)	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
4	L4	0	1 and 2 and 3	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
5	L5	0	x-ray and limanography and circuit with board	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
6	L6	62	x-ray and laminography and circuit with board	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
7	L7	0	x-ray and laminography and circuit with board with holder	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0
8	L8	18317 3	printed with circuit with board	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM_TDB	0

	L #	Hits	Search Text	DBs	Errors
9	L9	18	8 and 2 and 3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	0
10	L10	2	6 and 2 and 3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	0

	Document ID	Title	Current OR	Current XRef	Inventor
1	US 6622289 B2	Methods for making contact device for making connection to an electronic circuit device and methods of using the same	716/4	324/754; 324/758; 324/761; 324/762; 716/12; 716/19	Saunders, J. Lynn et al.
2	US 6496026 B1	Method of manufacturing and testing an electronic device using a contact device having fingers and a mechanical ground	324/762	324/754	Long, Tommy et al.
3	US 6343369 B1	Methods for making contact device for making connection to an electronic circuit device and methods of using the same	716/4		Saunders, J. Lynn et al.
4	US 6173750 B1	Method and apparatus for removing die from a wafer and conveying die to a pickup location	156/584	156/344; 29/426.3; 29/426.6; 438/464	Davis, Peter et al.
5	US 6091256 A	Contact device for making connection to an electronic circuit device	324/762	324/757	Long, Tom et al.
6	US 6046599 A	Method and device for making connection	324/762	324/72.5; 324/754; 324/758	Long, Tommy et al.
7	US 5863141 A	Image-related device with printed-circuit assembly cantilevered from sheet-metal base & with clip fastenings	400/692	361/753; 361/759; 400/693	Hong, Juehui et al.
8	US 5833161 A	Low profile mechanism for biased driving of driven roller in tape cartridge	242/352.4	242/349; 242/356.7	Nayak, Ash et al.
9	US 5621333 A	Contact device for making connection to an electronic circuit device	324/762	324/754	Long, Tom et al.
10	US 5620286 A	Flycutting machine for manufacturing printed circuit boards	409/157	409/184; 409/188; 409/195	Youden, David H.
11	US 5033185 A	Electronic component mounting apparatus	29/740	29/714; 29/743	Hidese, Wataru

	Document ID	Title	Current OR	Current XRef	Inventor
<del>12</del>	US 4724465 A	Photofabrication using laser light to expose photoresist	355/53	355/77	Davies, Howard J.
<del>13</del>	US 4351468 A	Apparatus for wiring connections on a substrate	228/4.5	156/548; 219/56.1; 29/850	Floury, Claude P. et al.
<i>This</i> <del>14</del>	US 2003005 8993 A1	Positioning mechanism providing precision 2-axis rotation, 1-axis translation adjustment	378/68		Bohn, David D.
<del>15</del>	US 2003005 8993 A	Positioning mechanism for image-based inspection system, has struts positioned by guide allowing object under inspection to translate vertically and to rotate about two horizontal axis			BOHN, D D
<del>16</del>	US 2002006 6063 A1	Methods for making contact device for making connection to an electronic circuit device and methods of using the same	716/4	716/8	Saunders, J. Lynn et al.
<del>17</del>	US 2002000 6327 A1	Manipulator	414/729		Stuyt, Henricus Johannes Adrianus
<del>18</del>	GB 2184855 A	Pattern photo-fabrication of photo-resist coated surface - using laser light beam focused onto surface of workpiece which is moved such that all parts of surface are brought into exposure position			DAVIES, H J